

## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	Integrated Lead Suspension for High Density Drive
Application Number:	09/676216
Confirmation Number:	1147
First Named Applicant:	Tzong-Shii Pan
Attorney Docket Number:	
Art Unit:	2653
Examiner:	Angel A. Castro
Search string:	( 6137657 or 6181525 or 6266212 or 6233121 or 6320729 or 6367145 or 6426851 or 6538850 or 6611402 or 20020051324 or 20020075602 ).pn.

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### US Patent Documents

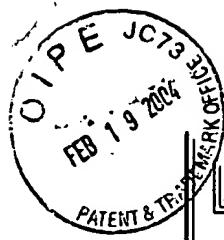
Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
AC	1	6137657	2000-10-24	Coon, et al.			
AC	2	6181525	2001-01-30	Carlson			
AC	3	6266212	2001-07-24	Coon			
AC	4	6233121	2001-05-15	Pan			
AC	5	6320729	2001-11-20	Coon			
AC	6	6367145	2002-04-09	Coon			
AC	7	6426851	2002-07-30	Perez			
AC	8	6538850	2003-03-25	Hadian, et al.			
AC	9	6611402	2003-08-26	Mangold			

### US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
AC	1	20020051324	2002-05-02	Nojima			



AC	2	20020075602	2002-06-20	Mangold, et al.
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## Remarks

Note: Remarks are not for responding to an office action.

The U.S. Patent references noted in this Electronic Information Disclosure Statement were cited along with foreign references in a recent office action in copending application serial no. 10/057,639. On Feb. 18, 2004, Applicant submitted by mail an Information Disclosure Statement with form PTO-1449, citing only the foreign references, along with the fee payment required under 37 CFR 1.17(p). On the same day, Applicant tried to concurrently submit the present Electronic Information Disclosure Statement, but due to technical difficulties with online filing, we were not able to complete the filing on the same day. However, the hardcopy filing had already been mailed. Applicant respectfully requests the present electronic submission not be subject to an additional filing fee.

## Signature

Examiner Name	Date
ANGEL CASTRO	3/18/05

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